

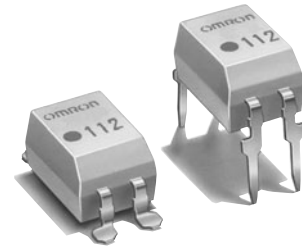
# G3VM-41AR/DR

MOS FET Relays

Higher power, 2.5-A switching with a 40-V load voltage, DIP package.

Low 50 mΩ ON Resistance.

- Continuous load current of 2.5 A.
- Switches minute analog signals.
- Dielectric strength of 2,500 Vrms between I/O.



**NEW**

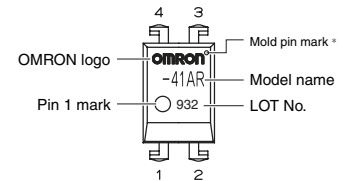
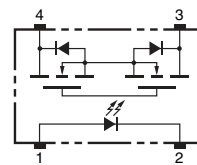
Note: The actual product is marked differently from the image shown here.

RoHS compliant

## Application Examples

- Communication equipment
- Test & Measurement equipment
- Security equipment
- Factory Automation equipment
- Power circuit

## Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.  
\* The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

## List of Models

Package type	Contact form	Terminals	Load voltage (peak value) *	Model	Minimum package quantity	
					Number per stick	Number per tape and reel
DIP4	1a (SPST-NO)	PCB terminals	40 V	G3VM-41AR	100	---
		Surface-mounting terminals		G3VM-41DR		
				G3VM-41DR (TR)	---	1,500

\* The AC peak and DC value are given for the load voltage.

## Absolute Maximum Ratings (Ta = 25°C)

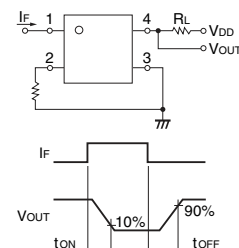
Item	Symbol	Rating	Unit	Measurement conditions	
Input	LED forward current	IF	30	mA	
	Repetitive peak LED forward current	IFP	1	A	100 μs pulses, 100 pps
	LED forward current reduction rate	ΔIF/°C	-0.3	mA/°C	Ta ≥ 25°C
	LED reverse voltage	VR	5	V	
Connection temperature	TJ	125	°C		
Output	Load voltage (AC peak/DC)	VOFF	40	V	
	Continuous load current (AC peak/DC)	Io	2.5	A	
	ON current reduction rate	ΔIo/°C	-25	mA/°C	Ta ≥ 25°C
	Pulse ON current	Iop	7.5	A	t = 100 ms, Duty = 1/10
Connection temperature	TJ	125	°C		
Dielectric strength between I/O (See note 1.)	Vi-o	2500	Vrms	AC for 1 min	
Operating temperature	Ta	-40 to +85	°C	With no icing or condensation	
Storage temperature	Tstg	-55 to +125	°C	With no icing or condensation	
Soldering temperature	---	260	°C	10 s	

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

## Electrical Characteristics (Ta = 25°C)

Item	Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions	
Input	LED forward voltage	VF	1.18	1.33	1.48	V	IF = 10 mA
	Reverse current	IR	---	---	10	μA	VR = 5 V
	Capacity between terminals	CT	---	70	---	pF	V = 0, f = 1 MHz
	Trigger LED forward current	IFT	---	0.5	3	mA	Io = 1 A
Output	Maximum resistance with output ON	RON	---	50	150	mΩ	IF = 5 mA, Io = 2 A, t < 1 s
	Current leakage when the relay is open	I <sub>LEAK</sub>	---	---	1.0	μA	VOFF = 40 V
	Capacity between terminals	COFF	---	300	---	pF	V = 0, f = 1 MHz
	Capacity between I/O terminals	CI-o	---	0.8	---	pF	f = 1 MHz, Vs = 0 V
Insulation resistance between I/O terminals	RI-o	1000	---	---	MΩ	Vi-o = 500 VDC, RoH ≤ 60%	
Turn-ON time	tON	---	0.8	5	ms	IF = 5 mA, RL = 200 Ω, VDD = 20 V (See note 2.)	
Turn-OFF time	tOFF	---	0.3	1	ms		

Note: 2. Turn-ON and Turn-OFF Times



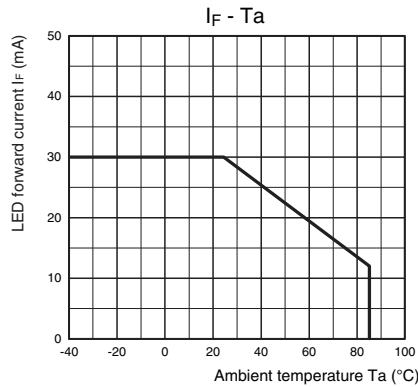
## Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

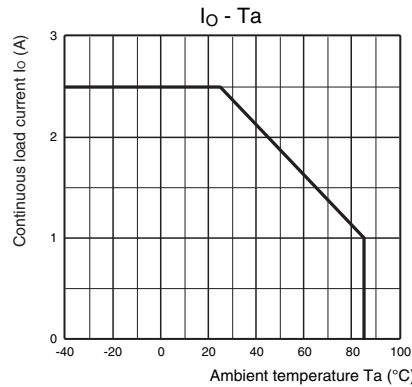
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	$V_{DD}$	---	---	32	V
Operating LED forward current	$I_F$	5	10	25	mA
Continuous load current (AC peak/DC)	$I_O$	---	---	2.5	A
Operating temperature	$T_a$	-20	---	65	°C

## Engineering Data

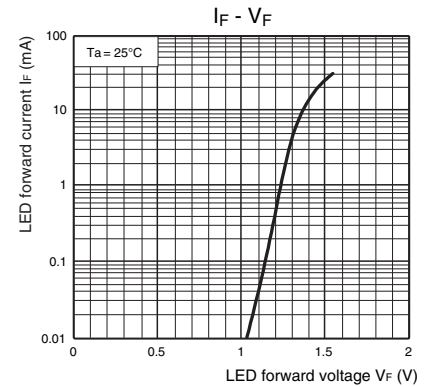
LED forward current vs. Ambient temperature



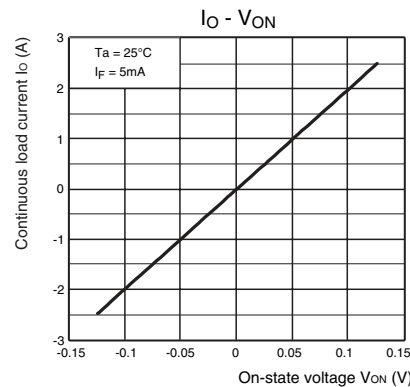
Continuous load current vs. Ambient temperature



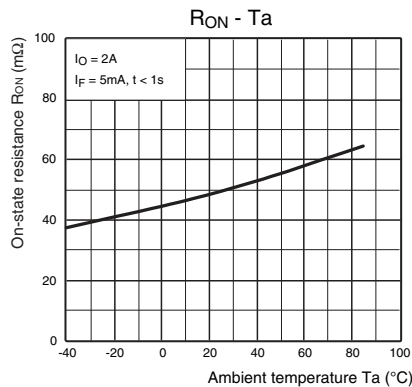
LED forward current vs. LED forward voltage



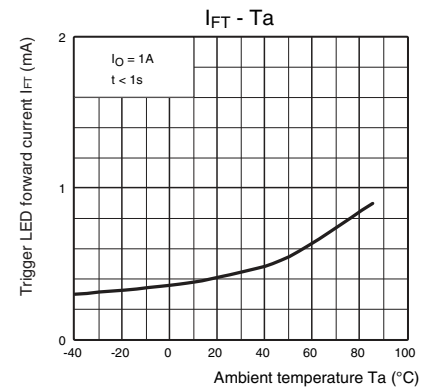
Continuous load current vs. On-state voltage



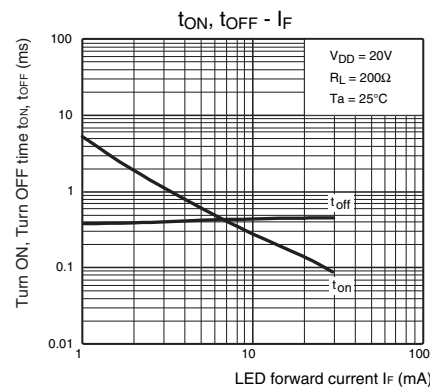
On-state resistance vs. Ambient temperature



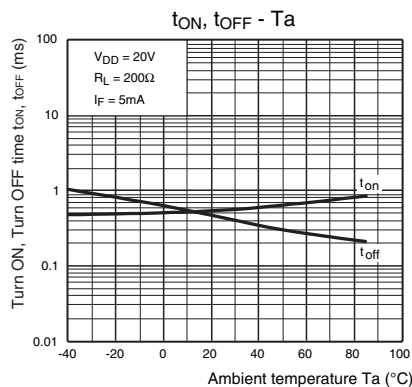
Trigger LED forward current vs. Ambient temperature



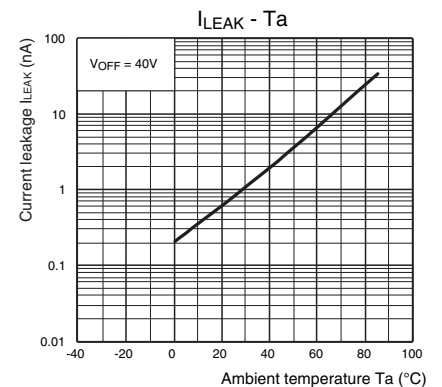
Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Ambient temperature



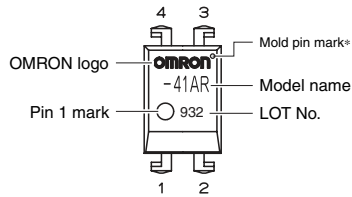
## Safety Precautions

- Refer to "Common Precautions" for all G3VM models.

## ■ Appearance

### DIP (Dual In-line Package)

DIP4

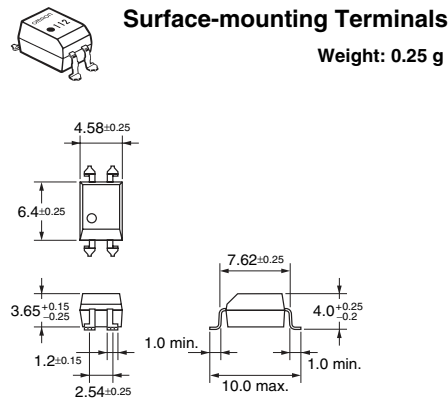
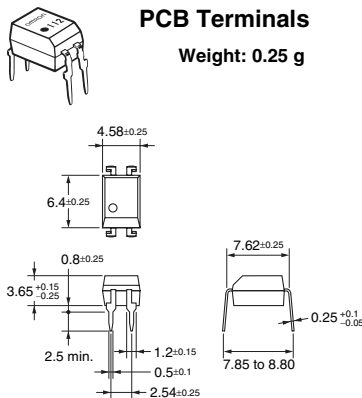


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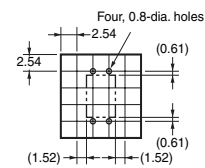
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## ■ Dimensions

(Unit: mm)

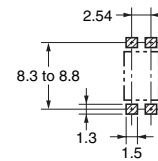


### PCB Dimensions (Bottom View)



### Actual Mounting Pad Dimensions

(Recommended Value, Top View)



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- Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
- Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

**Note:** Do not use this document to operate the Unit.